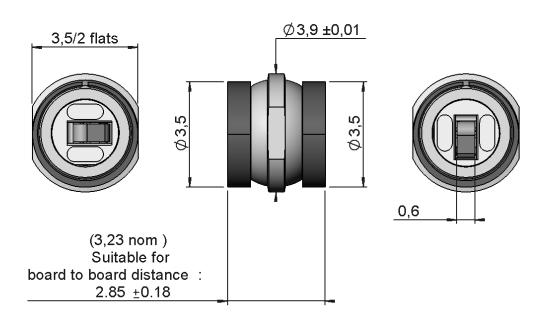




DOUBLE BOARD TO BOARD CONNECTOR SOLDER TYPE

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All dimensions are in mm. Tolerances according ISO 2768 m-H



COMPONENTS	MATERIALS	PLATING (μm)
D .		
Body	BRONZE	NPGR
Center contact	BERYLLIUM COPPER	GOLD 1.3 OVER NICKEL2
Outer contact		
Insulator	PEEK	
Gasket		
Others parts	BERYLLIUM COPPER	NPGR
-	-	-
-	-	-



Technical Data Sheet

DOUBLE BOARD TO BOARD CONNECTOR SOLDER TYPE

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PACKAGING

Standard	Unit	Other
100	Contact us	Contact us

ELECTRICAL CHARACTERISTICS

 $\begin{array}{ccc} \text{Impedance} & & \textbf{50} & \Omega \\ \text{Frequency} & & \textbf{0-18} & \text{GHz} \end{array}$

x F(GHz) Maxi √F(GHz) dB Maxi VSWR 0,0000 Insertion loss - F(GHz)) dB Maxi RF leakage NA Voltage rating 225 Veff Maxi Dielectric withstanding voltage 500 Veff mini Insulation resistance 1000 $M\Omega$ mini

MECHANICAL CHARACTERISTICS

Center contact retention

Recommended torque

Mating NA N.cm Na nl.cm

Mating life 50 Cycles mini Nominal Weight 0,1600 g (Add +15% for max

weight)

ENVIRONMENTAL

Operating temperature -55/+125 °C
Hermetic seal NA Atm.cm3/s
Panel leakage NA

SPECIFICATION

OTHER CHARACTERISTICS

Assembly instruction:

Others:

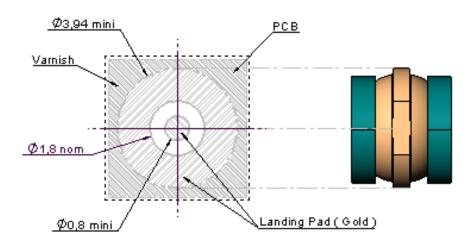
*VSWR: 1.3max DC-12GHz *VSWR: 1.55 max -->18GHz **0.25dB max at 18Ghz



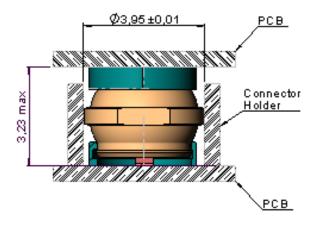


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2 - UNCOMPRESSED



3 - COMPRESSED

